















ESD

TVS

MOS

LDO

Diode

Sensor

DC-DC

Product Specification

Domestic Part Number	100N03A
Overseas Part Number	100N03A
▶ Equivalent Part Number	100N03A





Rectifier Diodes

N-Channel Power MOSFET

V _{(BR)DSS}	$R_{DS(on)}MAX$	I _D
201	4 mΩ@10V	80A
30V	7mΩ@ 5V	

1. GATE 2. DRAIN 3. SOURCE

DESCRIPTION

The MOSFET uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

FEATURES

- High density cell design for ultra low R_{DS(ON)}
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}

APPLICATIONS

- Power switching application
- · Hard switched and high frequency circuits

Excellent package for good heat dissipation

Uninterruptible Power Supply

Special process technology for high ESD capability

EQUIVALENT CIRCUIT



MAXIMUM RATINGS (T_a=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	٧
Continuous Drain Current	ID	80	Α
Pulsed Drain Current	I _{DM}	320	Α
Single Pulsed Avalanche Energy	E _{AS} ⁽¹⁾	306	mJ
Power Dissipation	PD	1.25	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	100	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T _{stg}	-55 ~+150	℃
Lead Temperature for Soldering Purposes(1/8" from case for 10s)	TL	260	°C

^{(1).} E_{AS} condition: V_{DD} =20V,L=0.5mH, R_{G} =25 Ω , Starting T_{J} = 25 $^{\circ}$ C



Rectifier Diodes

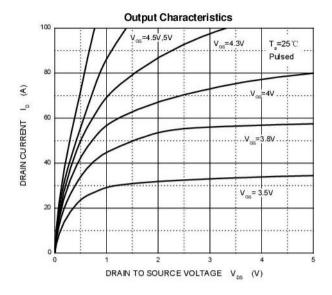
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit			
Off characteristics									
Drain-source breakdown voltage	V(BR) DSS	Vgs = 0V, Ip =250µA	30			V			
Zero gate voltage drain current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1	μΑ			
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA			
On characteristics (note1)									
Gate-threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0	1.5	3.0	V			
Static drain-source on-sate resistance	_	Vgs =10V, ID =30A		3	4	mΩ			
	RDS(on)	Vgs =5V, ID =24A		4.2	7	mΩ			
Forward transconductance	g _{FS}	V _{DS} =5V, I _D =24A	20			s			
Dynamic characteristics (note 2)									
Input capacitance	C _{iss}			2330		pF			
Output capacitance	Coss	Vps =15V,Vgs =0V, f =1MHz		460					
Reverse transfer capacitance	C _{rss}			230					
Switching characteristics (note 2)									
Total gate charge	Qg	V _{DS} =10V, V _{GS} =10V,		51		nC			
Gate-source charge	Q _{gs}			14					
Gate-drain charge	Q_{gd}	10-30/		11					
Turn-on delay time	t _{d(on)}			20		ns			
Turn-on rise time	tr	V_{DD} =15V, I_D =30A, V_{GS} =10V, R_G =2.7 Ω		15					
Turn-off delay time	td(off)			60					
Turn-off fall time	tr			10					
Drain-Source Diode Characteristics									
Drain-source diode forward voltage(note1)	V _{SD}	V _{GS} =0V, I _S =24A			1.2	V			
Continuous drain-source diode forward current	Is				80	Α			
Pulsed drain-source diode forward current	I _{SM}				320	Α			

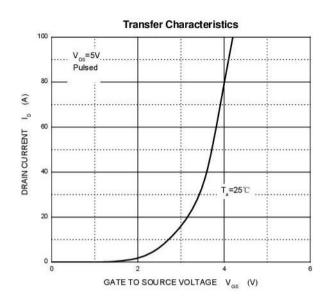
Notes:

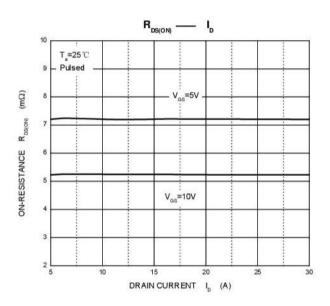
- 1. Pulse Test : Pulse Width≤300µs, duty cycle ≤2%.
- 2. Guaranteed by design, not subject to production.

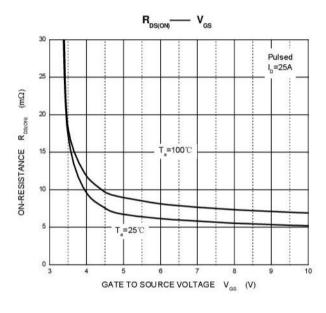


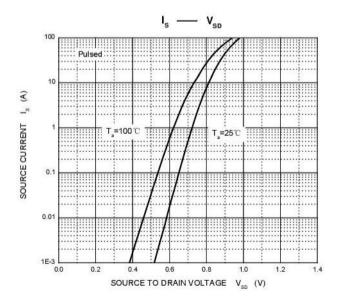
Rectifier Diodes

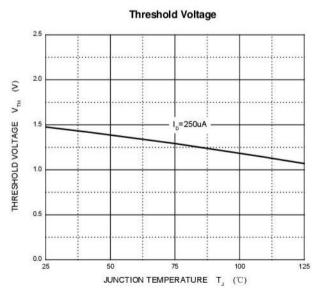














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